Form PTO-1595 (Rev. 06/04) OMB No. 0651-0027 (exp. 6/30/2005)	05-12-2		U.S. DEPARTMENT C ited States Patent and Tra	
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Name of conveying party(ies)/E	Execution Date(s):	2. Name and address	of receiving party(ies)
		Name: <u>Taiwan Semico</u> i	nductor Manufacturing	Company,
Chi-Hsuen Chang Jun Xiu Liu		Internal Address:		
Tsung-Yi Huang				
Chung-I Chen		Chrook Address No. 0	Li Hain Del 6	
Tzu-Chiang Sung Chih Po Huang		Street Address: No. 8,		0
Rann Shyan Yeh		Science-Based Industria		327
·	_	City: <u>Hsin-Chu</u>		90
Execution Date(s) April 29, 2009 Additional name(s) of conveying party(ies) attact		State:		-52
3. Nature of conveyance:		Country: Taiwan , ROC	Zip: <u>300-77</u>	72
X Assignment	Merger			72
Security Agreement	Change of Name			•
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Government Interest Assi				
Executive Order 9424, Co	onfirmatory License			
Other				
		Additional name(s) & addre	ess(es) attached?	Yes X 1
Application or patent number A. Patent Application No.(s)	(s): X This	document is being filed too B. Patent No.(s)	gether with a new applica	ition.
	Additional numbers atta	B. Patent No.(s)	gether with a new applica	tion.
	Additional numbers atta	B. Patent No.(s)	No	
A. Patent Application No.(s) Name and address to whom concerning document should be	Additional numbers atta	B. Patent No.(s) ched? Yes X 6. Total number of ap involved: 7. Total fee (37 CFR 1	No plications and patent 1 .21(h) & 3.41) \$	s 40.00
A. Patent Application No.(s) 5. Name and address to whom co concerning document should be Name: Mark E. Courtney	Additional numbers atta	B. Patent No.(s) ched? Yes X 6. Total number of ap involved: 7. Total fee (37 CFR 1	No plications and patent	s 40.00
A. Patent Application No.(s) 5. Name and address to whom coconcerning document should be Name: Mark E. Courtney Slater & Matsil, L.L.P.	Additional numbers atta	B. Patent No.(s) ched? Yes X 6. Total number of ap involved: 7. Total fee (37 CFR 1 Authorized to be	No plications and patent 1 .21(h) & 3.41) \$	s 40.00 rd
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A. Patent Application No.(s) 5. Name and address to whom coconcerning document should be Name: Mark E. Courtney Slater & Matsil, L.L.P. Internal Address: Street Address: 17950 Preston Rd. Suite 1000 City: Dallas State: Texas Zip: Phone Number: 972-732-1001	Additional numbers atta	B. Patent No.(s) ched? Yes X 6. Total number of ap involved: 7. Total fee (37 CFR 1 Authorized to be Enclosed None required S. Payment Information	No plications and patent 1 .21(h) & 3.41) \$ be charged by credit can be charged to deposit a (government interest not	\$ 40.00 rd account
A. Patent Application No.(s) 5. Name and address to whom coconcerning document should be Name: Mark E. Courtney Slater & Matsil, L.L.P. Internal Address: Street Address: 17950 Preston Rd. Suite 1000 City: Dallas State: Texas Zip: Phone Number: 972-732-1001 Fax Number: 972-732-9218	Additional numbers atta	B. Patent No.(s) ched? Yes X 6. Total number of ap involved: 7. Total fee (37 CFR 1 Authorized to be Enclosed None required 8. Payment Information a. Credit Card Last 4	No plications and patent 1 .21(h) & 3.41) \$ pe charged by credit can be charged to deposit a (government interest not) On Numbers	\$ 40.00 rd account
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A. Patent Application No.(s) 5. Name and address to whom coconcerning document should be Name: Mark E. Courtney Slater & Matsil, L.L.P. Internal Address: Street Address: 17950 Preston Rd. Suite 1000 City: Dallas State: Texas Zip: Phone Number: 972-732-1001 Fax Number: 972-732-9218 Email Address: courtney@slater-market	Additional numbers atta	B. Patent No.(s) ched? Yes X 6. Total number of ap involved: 7. Total fee (37 CFR 1 Authorized to be Enclosed None required 8. Payment Information a. Credit Card Last 4 Expirate	plications and patent 1 .21(h) & 3.41) \$.2e charged by credit can be charged to deposit a (government interest not n Numbers tion Date nber50-1065	\$ 40.00 rd account
5. Name and address to whom coconcerning document should be Name: Mark E. Courtney Slater & Matsil, L.L.P. Internal Address: Street Address: 17950 Preston Rd. Suite 1000 City: Dallas State: Texas Zip: Phone Number: 972-732-1001 Fax Number: 972-732-9218 Email Address: courtney@slater-mail DBYRNE 00000163 501065 1112263	Additional numbers atta	B. Patent No.(s) ched? Yes X 6. Total number of ap involved: 7. Total fee (37 CFR 1 Authorized to be Enclosed None required 8. Payment Information a. Credit Card Last 4 Expirate b. Deposit Account Number 1	Plications and patent 1 .21(h) & 3.41) \$ be charged by credit can be charged to deposit a (government interest not on	s 40.00 rd account affecting title
A. Patent Application No.(s) 5. Name and address to whom coconcerning document should be Name: Mark E. Courtney Slater & Matsil, L.L.P. Internal Address: Street Address: 17950 Preston Rd. Suite 1000 City: Dallas State: Texas Zip: Phone Number: 972-732-1001 Fax Number: 972-732-9218 Email Address: courtney@slater-mail Address: courtney@slater-mail 11263	Additional numbers atta	B. Patent No.(s) ched? Yes X 6. Total number of ap involved: 7. Total fee (37 CFR 1 Authorized to be Enclosed None required 8. Payment Information a. Credit Card Last 4 Expirate b. Deposit Account Number 1	plications and patent 1 .21(h) & 3.41) \$.2e charged by credit can be charged to deposit a (government interest not n Numbers tion Date nber50-1065	s 40.00 rd account affecting title

Documents to be recorded (including cover sheet) should be faxed to (703) 306-5995, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, V.A. 22313-1450

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd. (TSMC), a corporation organized and existing under the laws of Taiwan, the Republic of China, with its principal office at No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, R.O.C., is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TSMC, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TSMC, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to TSMC, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TSMC, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TSMC, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

TITLE OF INVENTION	Method ar	evice having		
SIGNATURE OF INVENTOR AND NAME	Chi-Hsuen Chang	Jun Xiu Liu Jun Xiu Liu	Tsung-Yi Huang	Chang - Chen Chung-1 Chen
DATE	4/28/2005	1/29 105	4/29 '05	4/29 '2005
RESIDENCE (City, County, State)	Hsin-Chu, Taiwan, R.O.C.	Hsin-Chu, Taiwan, R.O.C.	Hsin-Chu, Taiwan, R.O.C.	Hsin-Chu, Taiwan, R.O.C.

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Page 1 of 2

Assignment

MOAT **EXTENT** MOST YAM-SO

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ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd. (TSMC), a corporation organized and existing under the laws of Taiwan, the Republic of China, with its principal office at No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, R.O.C., is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TSMC, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TSMC, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to TSMC, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TSMC, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TSMC, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

TITLE OF INVENTION	Method for Controlling High Voltage Device Id-Vg Curve Characteristic by Controlling the STI Transition Angle and Circuit Constructed Thereby				
SIGNATURE OF INVENTOR AND NAME	Tzu-chiany Sung	Chih Po Huang Chih Po Huang	Cann Shyorn Fel Rann Shyan Yeh		
DATE	4/4 1 20-5	4/29 2005	4/29 12005		
RESIDENCE (City, County, State)	Jhubel City, Taiwan, R.O.C.	Hsin-Chu, Taiwan, R.O.C.	Hsin-Chu, Taiwan, R.O.C.		

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Page 2 of 2

Assignment

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